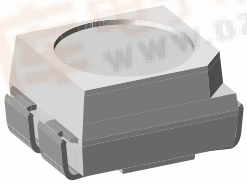
Bicolor SMD LED PLCC-3



19140_1

FEATURES

- SMD LED with exceptional brightness
- Multicolored
- Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with IR reflow, vapor phase and wave soldering processes according to CECC 00802 and J-STD-020-C
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} \leq 2.0$
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC
- Lead (Pb)-free device
- Preconditioning: acc. to JEDEC level 2a
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B

DESCRIPTION

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the VLMV3100 is the PLCC-3.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

This SMD device consists of a red and green chip. So it is possible to choose the color in one device.

APPLICATIONS

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols
- General use

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-3
- Product series: bicolor
- Angle of half intensity: ± 60°

PARTS TABLE

PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
VLMV3100-GS08	Green/red, I_V > 2.8 mcd	GaP on GaP/GaAsP on GaP
VLMV3100-GS18	Green/red, I_V > 2.8 mcd	GaP on GaP/GaAsP on GaP

ABSOLUTE MAXIMUM RATINGS[1] VLMV3100				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Reverse voltage per diode[2]	I_R = 10 µA	V_R	6	V
DC Forward current per diode	$T_{amb} \leq 60$ °C	I_F	30	mA
Surge forward current per diode	$t_p \leq 10$ µs	I_{FSM}	0.5	A
Power dissipation per diode		P_V	100	mW
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	- 40 to + 100	°C
Storage temperature range		T_{stg}	- 40 to + 100	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm^2)	R_{thJA}	400	K/W

Note:
[1] T_{amb} = 25 °C unless otherwise specified
[2] Driving the LED in reverse direction is suitable for a short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS[1] VLMV3100, RED						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN**	**TYP.**	**MAX**	**UNIT**
Luminous intensity[2]	I_F = 10 mA	I_V	2.8	6		mcd
Dominant wavelength	I_F = 10 mA	λ_d	612		625	nm
Peak wavelength	I_F = 10 mA	λ_p		635		nm
Angle of half intensity	I_F = 10 mA	φ		± 60		deg
Forward voltage per diode	I_F = 20 mA	V_F		2.4	3	V
Reverse current per diode	V_R = 6 V	I_R			10	µA
Junction capacitance per diode	V_R = 0, f = 1 MHz	C_j		15		pF

Note:
[1] T_{amb} = 25 °C unless otherwise specified
[2] in one packing unit $I_{Vmax}/I_{Vmin} \leq 0.5$

OPTICAL AND ELECTRICAL CHARACTERISTICS[1] VLMV3100, GREEN						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN**	**TYP.**	**MAX**	**UNIT**
Luminous intensity[2]	I_F = 10 mA	I_V	2.8	6		mcd
Dominant wavelength	I_F = 10 mA	λ_d	562		575	nm
Peak wavelength	I_F = 10 mA	λ_p		565		nm
Angle of half intensity	I_F = 10 mA	φ		± 60		deg
Forward voltage per diode	I_F = 20 mA	V_F		2.4	3	V
Reverse current per diode	V_R = 6 V	I_R			10	µA
Junction capacitance per diode	V_R = 0, f = 1 MHz	C_j		15		pF

Note:
[1] T_{amb} = 25 °C unless otherwise specified
[2] in one Packing Unit $I_{Vmax}/I_{Vmin} \leq 0.5$

COLOR CLASSIFICATION		
GROUP	GREEN	
	DOM. WAVELENGTH [NM]	
	MIN.	MAX.
3	562	565
4	564	567
5	566	569
6	568	571
7	570	573
8	572	575

Note:
Wavelengths are tested at a current pulse duration of 25 ms and an accuracy of ± 1 nm.

LUMINOUS INTENSITY CLASSIFICATION			
GROUP	LIGHT INTENSITY [MCD]		
STANDARD	OPTIONAL	MIN	MAX
H	1	2.8	3.55
	2	3.55	4.5
J	1	4.5	5.6
	2	5.6	7.1
K	1	7.1	9.0
	2	9.0	11.2
L	1	11.2	14.0
	2	14.0	18.0
M	1	18.0	22.4
	2	22.4	28.0

Note:

Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ± 11 %.

The above Type Numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped on any one reel.

In order to ensure availability, single wavelength groups will not be orderable.

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

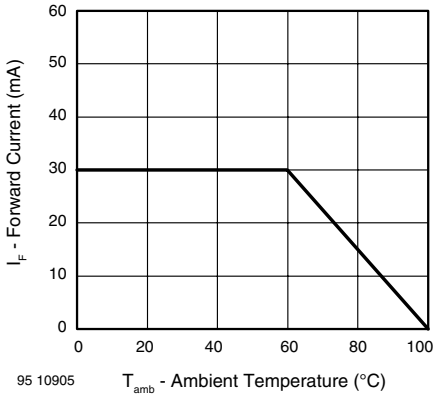


Figure 1. Forward Current vs. Ambient Temperature

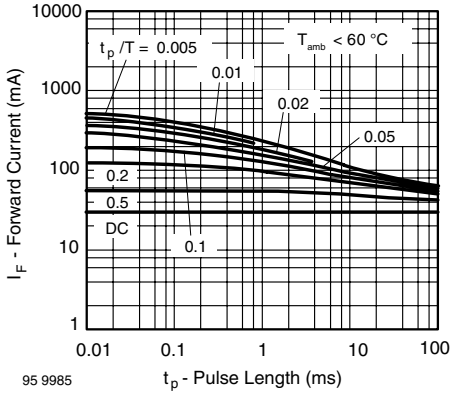


Figure 2. Pulse Forward Current vs. Pulse Duration

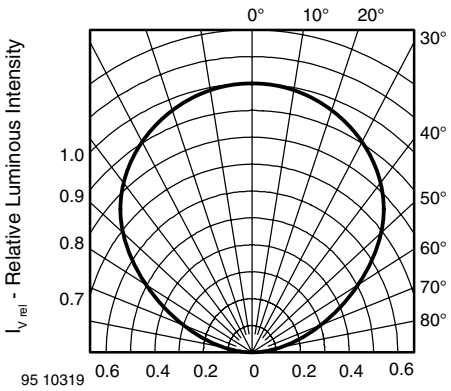


Figure 3. Rel. Luminous Intensity vs. Angular Displacement

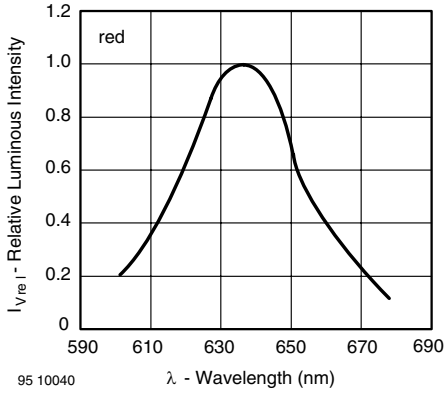


Figure 4. Relative Intensity vs. Wavelength

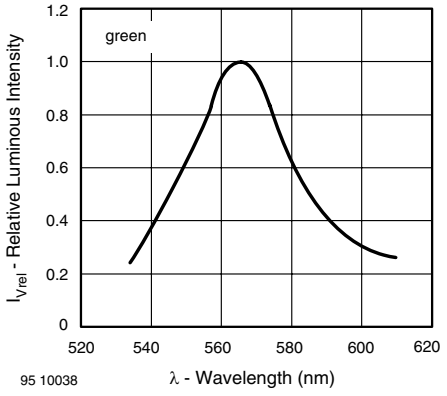


Figure 5. Relative Intensity vs. Wavelength

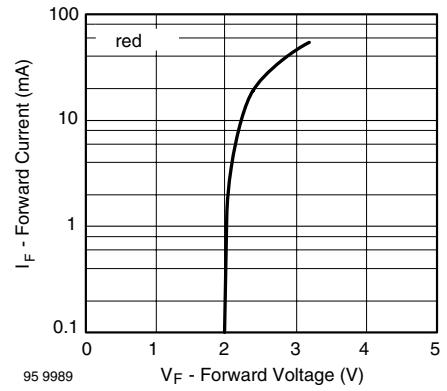


Figure 6. Forward Current vs. Forward Voltage

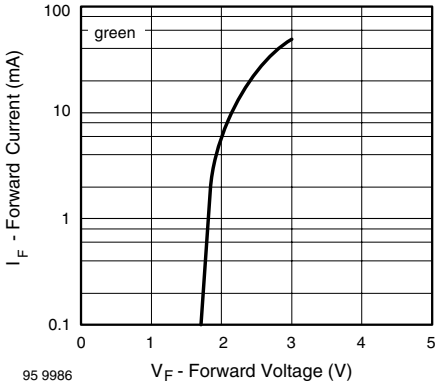


Figure 7. Forward Current vs. Forward Voltage

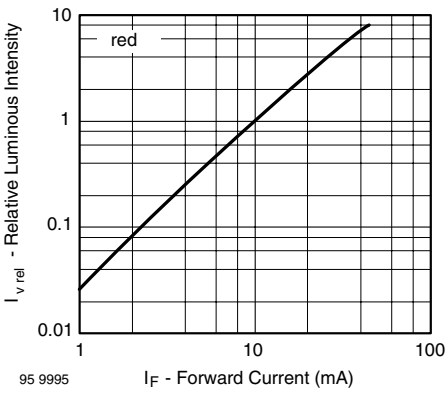


Figure 8. Relative Luminous Intensity vs. Forward Current

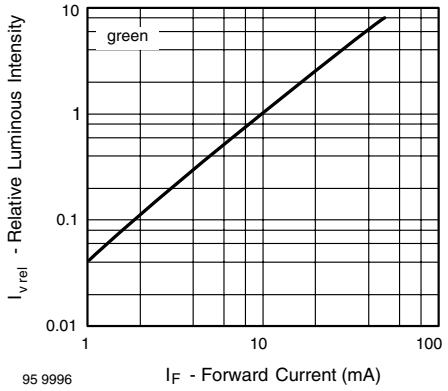


Figure 9. Relative Luminous Intensity vs. Forward Current

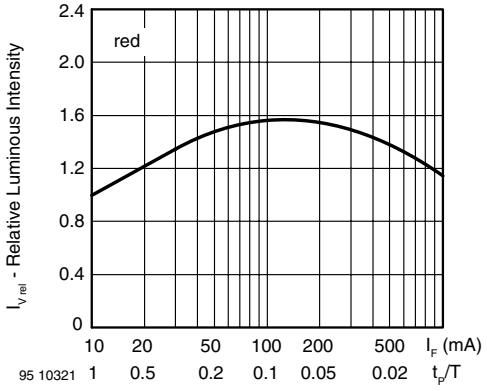


Figure 12. Rel. Luminous Intensity vs. Forw. Current/Duty Cycle

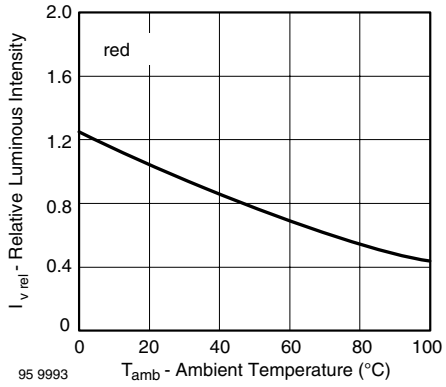


Figure 10. Rel. Luminous Intensity vs. Ambient Temperature

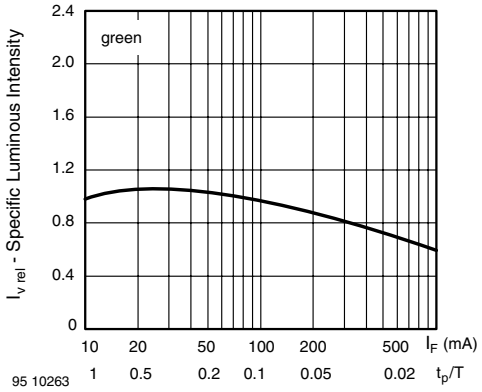


Figure 13. Specific Luminous Intensity vs. Forward Current

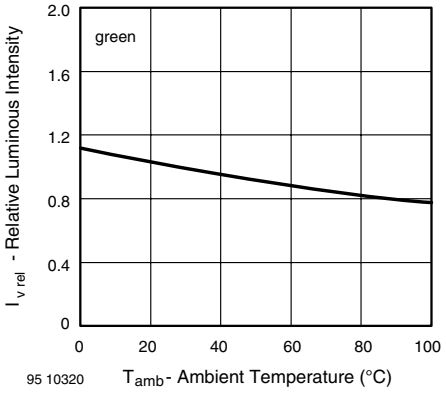
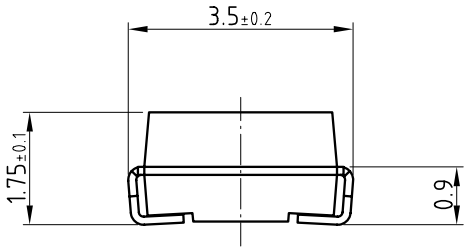
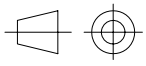
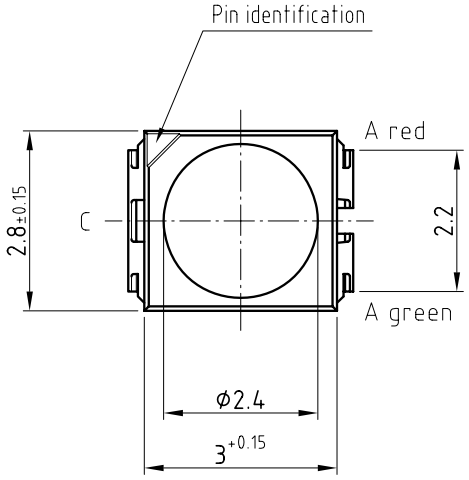


Figure 11. Rel. Luminous Intensity vs. Ambient Temperature

PACKAGE DIMENSIONS

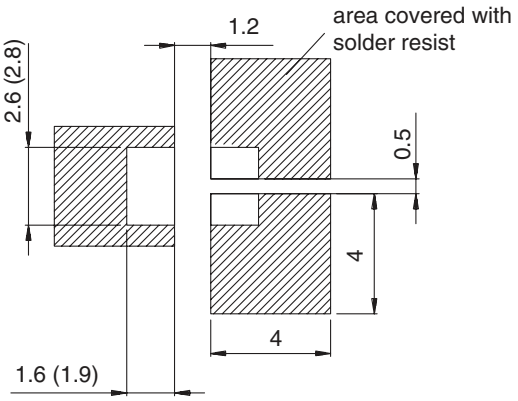






Drawing-No.: 6.541-5068.01-4
Issue: 2; 30.05.07

Mounting Pad Layout

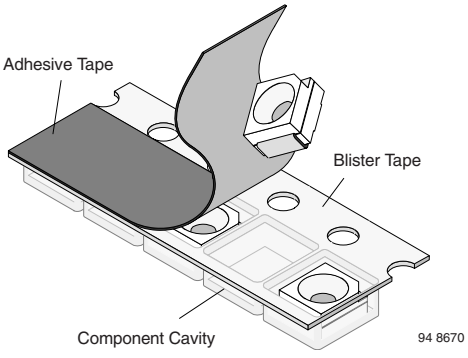


Dimensions: IR and Vaporphase
(Wave Soldering)

METHOD OF TAPING/POLARITY AND TAPE AND REEL

SMD LED (VLM.3 - SERIES)

Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO) 564) for automatic component insertion. The blister tape is a plastic strip with impressed component cavities, covered by a top tape.



TAPING OF VLM.3...

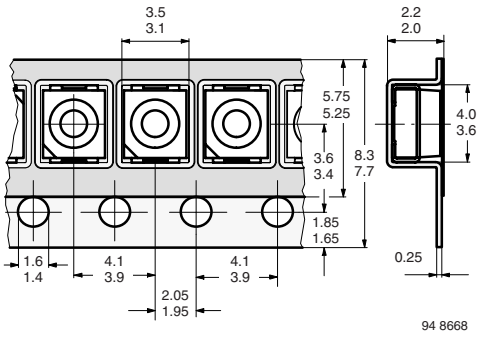


Figure 14. Tape Dimensions in mm for PLCC-2

REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS08 (= 1500 PCS.)

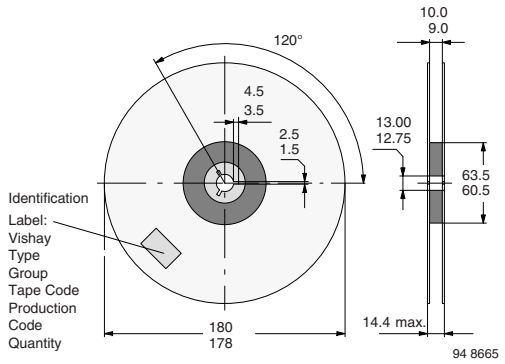


Figure 15. Reel Dimensions - GS08

REEL PACKAGE DIMENSION IN MM FOR SMD LEDS, TAPE OPTION GS18 (= 8000 PCS.) PREFERRED

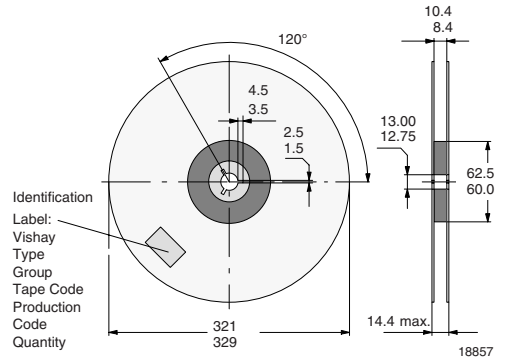


Figure 16. Reel Dimensions - GS18

SOLDERING PROFILE

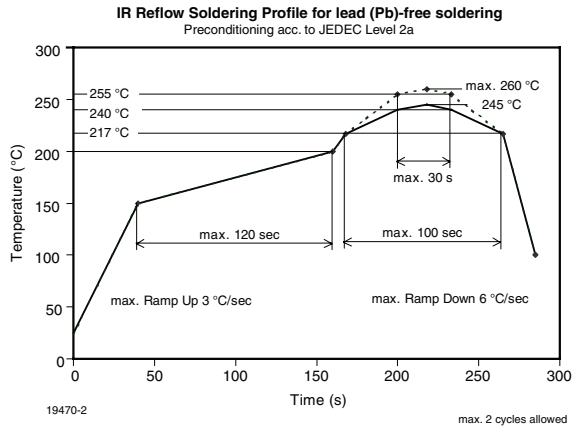


Figure 17. Vishay Lead (Pb)-free Reflow Soldering Profile (acc. to J-STD-020C)

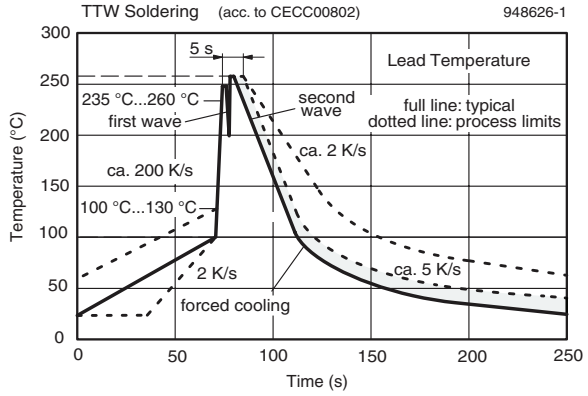
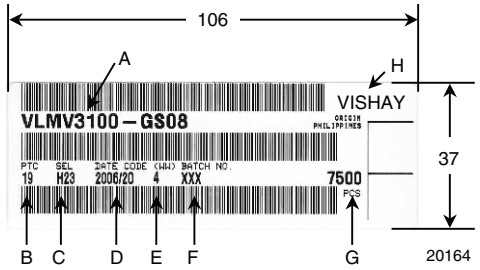


Figure 18. Double Wave Soldering of Opto Devices (all Packages)

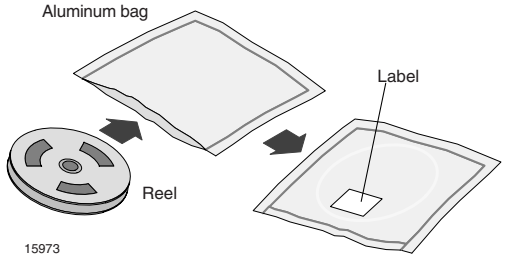
BAR CODE PRODUCT LABEL EXAMPLE:



A) Type of component
B) Manufacturing plant
C) SEL - selection code (bin):
e.g.: H2 = code for luminous intensity group
3 = code for color group
D) Date code year/week
E) Day code (e.g. 4: Thursday)
F) Batch no.
G) Total quantity
H) Company code

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminium bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

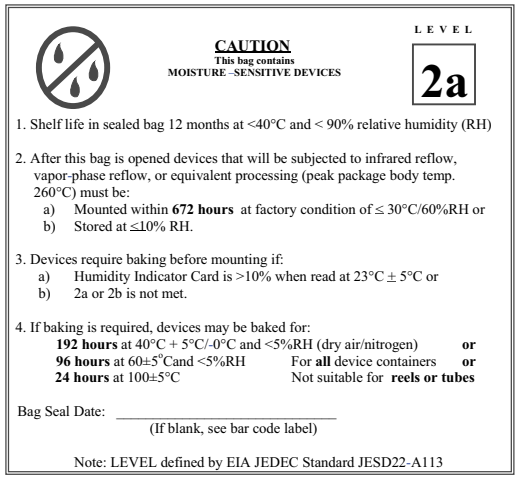
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C/ - 0 °C and < 5 % RH (dry air/ nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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